

SMD Ceramic Resonators

1. SCOPE

This specification shall cover the characteristics of the ceramic resonator with the type ZTTCE11.06MG.

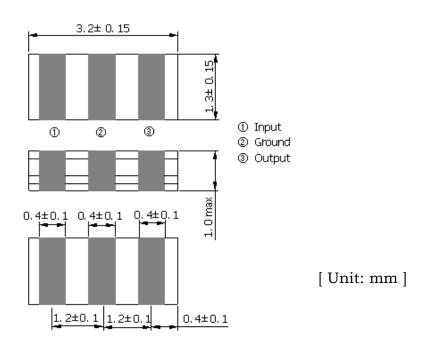
2. PART NO.:

| PART NUMBER | CUSTOMER PART NO | SPECIFICATION NO |
|--------------|------------------|------------------|
| ZTTCE11.06MG | | |

3. OUTLINE DRAWING AND DIMENSIONS:

Appearance: No visible damage and dirt.

Dimensions:





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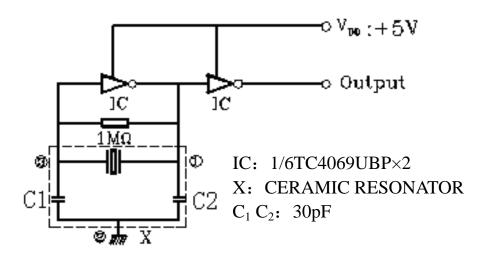
4. ELECTRICAL SPECIFICATIONS:

| No | Item | Requirements | | | |
|-----|--|---|--|--|--|
| 4.1 | Oscillation Frequency Fosc (MHz) | 11.06 | | | |
| | Frequency Accuracy (%) | ±0.5 | | | |
| 4.2 | Resonant Impedance Ro (Ω)max | 30 | | | |
| 4.3 | Temperature Coefficient of | ± 0.3 (Oscillation Frequency | | | |
| | Oscillation Frequency (%) max | drift -20° C to $+80^{\circ}$ C) | | | |
| 4.4 | Withstanding Voltage | 50 VDC, 1 min | | | |
| 4.5 | Rating Voltage U _R (V) | | | | |
| | (1) D.C. Voltage | 6 VDC. | | | |
| | (2) A.C. Voltage | 15 Vp-p. | | | |
| 4.6 | Insulation Resistance Ri, (M Ω) min | 100 (100V, 1min) | | | |
| | | | | | |
| 4.7 | Operating Temperature $(^{\circ}C)$ | -40∼+85 | | | |
| 4.8 | Storage Temperature $(^{\circ}\mathbb{C})$ | -55∼+85 | | | |
| 4.9 | Aging Rate (%) max | ± 0.3 (For 10 years) | | | |

5. MEASUREMENT:

Measurement Conditions: Parts shall be measured under a condition (Temp.: 20 ± 15 °C ,Humidity : 65 ± 20 % R.H.) unless the standard condition(Temp.: 25 ± 3 °C ,Humidity : 65 ± 5 % R.H.) is regulated to measure.

Test Circuit:





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6. PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

| No | Item | Condition of Test | | Performance | | | |
|-----|-------------|--|------------------|------------------|--|--|--|
| | | | | Requirements | | | |
| 6.1 | Humidity | Keep the resonator at 40±2°C and 90 | It shall fulfill | | | | |
| | | for 96±4 hours. Then Release the reso | the | | | | |
| | | the room Condition for 1 hour pri | or to the | specifications | | | |
| | | Measurement. | | in Table 1. | | | |
| 6.2 | Vibration | Subject the resonator to vibration for | or 2 hours | It shall fulfill | | | |
| | | each in x, y and z axis With the am | plitude of | the | | | |
| | | 1.5mm, the frequency shall be varied | uniformly | specifications | | | |
| | | between the limits of 10 Hz—55Hz. | | in Table 1. | | | |
| 6.3 | Mechanical | Drop the resonator randomly onto | a wooden | It shall fulfill | | | |
| | Shock | floor from the height of 100cm 3 time | s. | the | | | |
| | | | | specifications | | | |
| | | | | in Table 1. | | | |
| 6.4 | Soldering | Passed through the re-flow oven | under the | It shall fulfill | | | |
| | Test | following condition and left | at room | the | | | |
| | | temperature for 1 hour before measure | ement. | specifications | | | |
| | | Temperature at the surface of the | Time | in Table 1. | | | |
| | | substrate | | | | | |
| | | Preheat 150±5°C | 60±10 | | | | |
| | | | sec | | | | |
| | | Peak 240±5°C | 10±3 sec | | | | |
| 6.5 | Solder | Dipped in 230±5°C solder bath for | 3±0.5 sec | The terminals | | | |
| | Ability | seconds with rosin flux (25wt% | ethanol | shall be at | | | |
| | | solution.) | | least 95% | | | |
| | | | | covered by | | | |
| | | | | solder. | | | |
| 6.6 | High | Subject the resonator to 80±5°C for | 96 hours, | It shall fulfill | | | |
| | Temperature | then release the resonator into t | the room | the | | | |
| | Exposure | conditions for 1 hour prior to the mean | specifications | | | | |
| | | | | in Table 1. | | | |
| 6.7 | Low | Subject the resonator to -20±5°C for | | It shall fulfill | | | |
| | Temperature | then release the resonator into t | | the | | | |
| | Exposure | conditions for 1 hour prior to the measure | surement. | _ | | | |
| | | | | in Table 1. | | | |



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6. PHYSICAL AND ENVIRONMENAL CHARACTERISICS

(Continued from the preceding page)

| No | Item | Condition of Test | Performance |
|-----|-------------|--|----------------------|
| | | | Requirements |
| 6.8 | Temperature | Subject the resonator to -40 °C for 30 | It shall fulfill the |
| | Cycling | min. followed by a high temperature of | specifications in |
| | | 85°C for 30 min. | Table 1. |
| | | Cycling shall be repeated 5 times with a | |
| | | transfer time of 15 sec. At the room | |
| | | temperature for 1 hour prior to the | |
| | | measurement. | |
| 6.9 | Board | Mount a glass-epoxy board | Mechanical damage |
| | Bending | (Width=40mm,thickness=1.6mm),then bend it | such as breaks shall |
| | | to 1mm displacement and keep it for 5 seconds. | not occur. |
| | | (See the following figure) | |
| | | | |
| | | PRESS | |
| | | 20 | |
| | | PRESS HEAD | |
| | | D.U.T. 04 | |
| | | D.U.T. 0 | |
| | | | |
| | | 45±2 45±2 | |
| | | Ø5 SUPPORT BAR | |
| | | | |
| | | | |

TABLE 1

| Item | Specification |
|--|---------------|
| Oscillation Frequency Change △Fosc/Fosc (%) max | ±0.3 |
| Resonant Impedance Change $\triangle Ro(\Omega)$ max | ±10 |

Note: The limits in the above table are referenced to the initial measurements.



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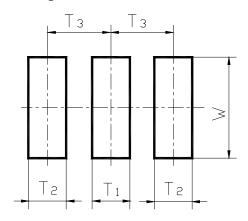
7. REVIEW OF SPECIFICATIONS

When something gets doubtful with this specifications, we shall jointly work to get an agreement.

8. RECOMMENDED LAND PATTERN AND REFLOW SOLDERING

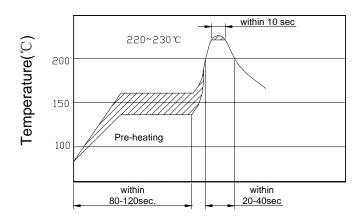
STANDARD CONDITIONS

8.1Recommended land pattern



| DIMENSIONS (mm) | | | | | | | | |
|--|--|--|--|--|--|--|--|--|
| $egin{array}{ c c c c c c c c c c c c c c c c c c c$ | | | | | | | | |
| 0.4±0.2 | | | | | | | | |

8.2Recommended reflow soldering standard conditions



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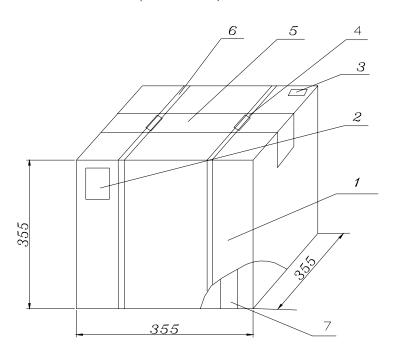
9. PACKAGE

To protect the products in storage and transportation, it is necessary to pack them (outer and inner package). On paper pack, the following requirements are requested.

Dimensions and Mark

At the end of package, the warning (moisture proof, upward put) should be stick to it.

Dimensions and Mark (see below)



| NO. | Name | Quantity | Notes |
|-----|-------------------------|----------|-------|
| 1 | Package | 1 | |
| 2 | Certificate of approval | 1 | |
| 3 | Label | 1 | |
| 4 | Tying | 2 | |
| 5 | Adhesive tape | 1.2m | |
| 6 | Belt | 2.9m | |
| 7 | Inner Box | 10 | |

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Section of package

Package is made of corrugated paper with thickness of 0.8cm.Package has 10 inner boxes, each box has 1 reel(each reel for plastic bag)

Quantity of package

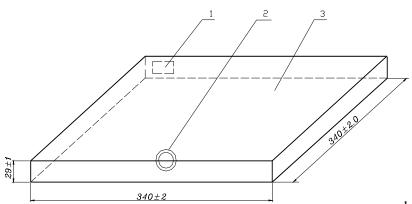
Per plastic reel 4000 pieces of piezoelectric ceramic part

Per inner box 1 reel

Per package 10 inner boxes (40000 pieces of piezoelectric

ceramic part)

Inner Packing Dimensions



1.UNIT: mm

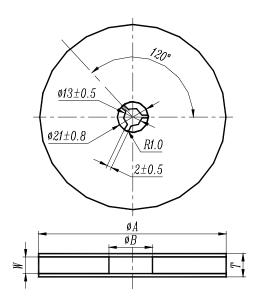
| 1 | Label | | | | | |
|---|-----------|--|--|--|--|--|
| 2 | QC Label | | | | | |
| 3 | Inner Box | | | | | |

Pars shall be packaged in box with hold down tape upside. Part No., quantity and lot No.



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8.5Reel

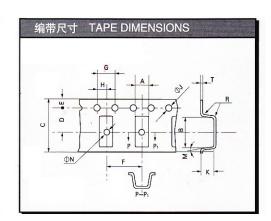


Dimensions Unit: mm

| ΦА | φВ | W | T | Pieces per reel | Carrier tape size | | |
|-------|-------|---------|---------|-----------------|-------------------|--|--|
| 330±3 | 80min | 16.4min | 22.4max | 4000typ. | 16 | | |

8.6Taping Dimensions

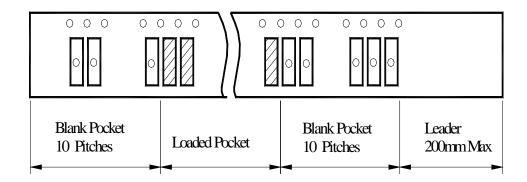
| 尺寸 标记 允差 Code 型 号 Tolerance Part Number | A ±0.2 | B ±0.2 | C ±0.3 | D ±0.1 | E ±0.1 | F ±0.1 | G ±0.1 | H ±0.1 | ØJ ±0.1 | Ø N ±0.1 | M max | R max | K ±0.2 | T ±0.1 |
|--|-----------|-----------|-----------|-----------|-----------|-----------|------------------|-----------|------------|--------------------|----------|----------|-----------|-----------|
| ZTA SS⊟MG | 3.8 | 7.8 | 16.0 | 7.5 | 1.75 | 8.0 | 4.0 | 2.0 | 1.5 | 1.6 | 10° | 0.3 | 2.1 | 0.3 |
| ZTACR MG | 2.2 | 4.7 | 12.0 | 5.5 | 1.75 | 4.0 | 4.0 | 2.0 | 1.6 | 1.6 | 3° | 0.3 | 1.3 | 0.3 |
| ZTTCE□MG | 1.5 | 3.4 | 8.0 | 3.5 | 1.75 | 4.0 | 4.0 | 2.0 | 1.6 | 1.1 | 3° | 0.3 | 1.3 | 0.2 |
| ZTACS MT/MX | 5.0 | 4.4 | 12.0 | 5.5 | 1.75 | 8.0 | 4.0 | 2.0 | 1.5 | 1.6 | 10° | 0.3 | 1.8 | 0.3 |
| ZTA SV∃MT/MX | 3.4 | 4.0 | 12.0 | 5.5 | 1.75 | 8.0 | 4.0 | 2.0 | 1.5 | 1.6 | 10° | 0.3 | 1.3 | 0.3 |
| ZTACW⊟MX ZTTCW⊟MX | 2.2 | 2.8 | 8.0 | 3.5 | 1.75 | 4.0 | 4.0 | 2,0 | 1.6 | 1.1 | 3° | 0.3 | 1.3 | 0.2 |





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8.7Packing Method Sketch Map



8.8Test Condition Of Peeling Strength

